	© Cop	terial Compo pyright 2005. IPC, Bannocl ternational and Pan-Americ	kburn, Illinois	. All rights reserve	tion with lower	level pa	arts, the	declaratio	n encoi		er level mate	erials for	which th	e item is an assembly ne manufacturer has leclaration.	
1/32-2 1.1		Veb Site for Informat		-1752 Standa	rd	Form Type * Distribute			Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Inform						
Supplier Information															
Company Name *	-	Company Unique ID		Unique ID Au	Ithority	Respo	nse Date	<b>)</b> *		Response Doc	ument ID				
SEMTECH CORPORATIO	00-847-9941		DUNS	2017-02-16											
Contact Name * Jeffrey Gabrielson		Title - Contact Quality Assurance cu	istomer su	Phone - Con 805-498-211	Email - Contact * jgabrielson@semtech.com			com	Duplicate Contact -> Authorized Representative						
Authorized Representative *         Title - Representative           Jeffrey Gabrielson         Quality Assurance				-	resentative * 1	Email - Representative * jgabrielson@semtech.com				Supplier Comr	nents or URL	. for Addi	tional Ir	nformation	
Requester Item Number		Mfr Item Number		Mfr Item Name	Effective	fective Date Version Mar			acturing Site	Weight *	UO	M	Unit Type		
	SC310ASKTRT			High-Side Cu	if		Malay		sia	17.56248	mg		Each		
Alternate Recommenda	Alternate Recommendation					Alternate Ite			Item Co	em Comments					
Manufacturing Proces	s Inf	ormation													
Terminal Plating / Grid Array N	/lateria	al	Terminal Ba	ase Alloy	J-STD-020 MSL Ra	ting F	Peak Proc	ess Body	Temper	rature Max Time	at Peak Tem	perature I	Number	of Reflow Cycles	
Matte Tin (Sn) CU Alloy Comments					:	<b>260</b> C	;	<b>30</b> se	conds	3					
SC310ASKTRT is REACH	H-cor	mpliant product, pe	r EU Regu	lation EC190	7/2006 to include	e recent	additio	n of SVH	IC can	didate list of s	ubstances i	n Janua	ry 2017	-	

Save the fields in this form to a file	Evport Data	Import fields from a file into this form	Import Data	Clear all of the fields on this form	Reset Form	Lock the fields on this form to prevent chan	Look Cupplier Fields						
<b>RoHS Materia</b>	RoHS Material Composition Declaration Declaration												
		ty limit of 0.1% by mass (100 Ethers (PBDE) and quantity					ominated Biphenyls (PBB),						
chromium, polybromina excess of an applicable gathered the information Company will rely on thi completing this form, ar certifications regarding conditions of that agree	ted biphenyls and/or polybrominate quantity limit, please indicate below it provides in this form using app s certification in determining the co d that Supplier may not have inde heir contributions to the part, and ment, including any warranty rights	ompliance of its products with European pendently verified such information. Ho those certifications are at least as comp	ricted substance?) in excess believe may apply. If the p y and that such information n Union member state laws owever, in situations where prehensive as the certificati hat agreement, will be the s	ss of the applicable quantity lim part is an assembly with lower I is true and correct to the best of that implement the RoHS Dire Supplier has not independently ion in this paragraph. If the Co sole and exclusive source of the	it identified above. If a homoge evel components, the declaration of its knowledge and belief, as of ctive. Company acknowledges y verified information provided lo popany and the Supplier enter is a Supplier?s liability and the Co	eneous material within the part cor on shall encompass all such comp of the date that Supplier complete: s that Supplier may have relied on by others, Supplier agrees that, at into a written agreement with resp impany?s remedies for issues that	ntains a RoHS restricted substance in ponents. Supplier certifies that it s this form. Supplier acknowledges that information provided by others in a minimum, its suppliers have provided						
RoHS Declaration	n * 1 - Item(s) does not conta	ain RoHS restricted substances per the	he definition above			Supplier Acceptance *	Accepted						
	e declared item does not co all applicable exemptions.	ntain RoHS restricted substanc	es per the definition a	above except for defined	RoHS exemptions, then	select the corresponding re	esponse in the RoHS Declaration						
Declaration S	ignature												
In a family of the second	ward a factor and the factor of the second s	al Calaba and all manages of the last		a second se	• • • • •	and the second s	terrestring and - Distingthe stars						

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

## Homogeneous Material Composition Declaration for Electronic Products

**Subltem Instructions:** The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	Item/SubItem				Homogeneous	Weight	Unit of			Level	Substance Category			Substance	CAS	Exempt	Weight	Unit of	Tolerance		PPM
		Name			Material	weight	Measure			Levei	Substance Category			Substance	CAS	Exempt	weight	Measure	-	+	FEINI
+I	-I	Die	+M -	·M	Doped Silicon	1	mg	+C	-C	Supplier		+S	-S	Si	7440-21-3		1	mg			56,939
+I	-1	Leadframe	+M -	·M	C194 Copper All	<b>0</b> 7.8	mg	+C	-C	Supplier		+S	Ş	Copper	7440-50-8		7.53402	mg			428,98
												+S	-s	Iron	7439-89-6		0.17597	mg			10,019
								+C	-C	A	Lead/Lead Compound	+S	-s	Lead	7439-92-1		0.00023	mg			13.32
								+C	-C	Supplier		+S	-s	Р	7723-14-0		0.00187	mg			106.59
												+S	-s	z	7440-66-6		0.00991	mg			564.04
												+S	-s	Ag	7440-22-4		0.078	mg			4,441.2
+I	-I	Die attach material	+M -	м	QMI519	0.07	mg	+C	-C	Supplier		+S	-s	Silver	7440-22-4		0.07	mg			3,786.4
			,,									+S	-s	Dicyclopentenyloxyethy	68586-19-6		0.003	mg			179.36
												+S	-s	Dicumyl peroxide	80-43-3		0.0004	mg			19.93
+I	-1	Wire	+M -	·M	Gold	0.17	mg	+C	-C	Supplier		+S	-s	Au	7440-57-5		0.17	mg			9,678.7
+I	-I	Encapsulation	+M -	м	CEL8240HF10	8.12	mg	+C	-C	Supplier		+S	-s	Epoxy resin-1	Proprietary		0.24	mg			13,870
												+S	-s	Epoxy resin-2	Proprietary		0.24	mg			13,870
												+S	-s	Phenol resin	Proprietary		0.37	mg			20,805
												+S	-s	Silica	60676-86-0		7.09	mg			403,63
												+S	-s	С	1333-86-4		0.02	mg			924.7
												+S	-s	Others	Proprietary		0.16	mg			9,246.9
+I	-I	Lead Finish	+M -	·M	Solder Alloy	0.40248	mg	+C	-C	Supplier		+S	-s	Sn	7440-31-5		0.40248	mg			22,917